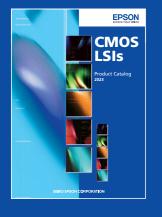


EPSON Microcontrollers



ASICs

EPSON ASSPs

America

Epson America, Inc. Headquarter: 3131 Katella Ave. Los Alamitos, CA 90720, USA Phone: +1-800-463-7766

San Jose Office: 2860 Zanker Road Suite 204 San Jose, CA 95134, USA Phone: +1-800-463-7766

Europe

Epson Europe Electronics GmbH

Riesstrasse 15, 80992 Munich, Germany Phone: +49-89-14005-0 FAX: +49-89-14005-110

Asia

Epson (China) Co., Ltd.

4th Floor, Tower 1 of China Central Place, 81 Jianguo Road, Chaoyang District, Beijing 100025 China Phone: +86-10-8522-1199 FAX: +86-10-8522-1120

Room 601-603, Building A One East, No.325 East Longhua Road, Shanghai 200023, China Phone: +86-21-5330-4888 FAX: +86-21-5423-4677

Shenzhen Branch

Room 804-805, 8 Floor, Tower 2, Ali Center, No.3331

Keyuan South RD(Shenzhen bay), Nanshan District, Shenzhen 518054, China Phone: +86-755-3299-0588 FAX: +86-755-3299-0560

Epson Taiwan Technology & Trading Ltd. 15F., No. 100, Songren Rd., Sinyi Dist., Taipei City 110. Taiwan Phone: +886-2-8786-6688

Epson Singapore Pte., Ltd.438B Alexandra Road, Block B Alexandra TechnoPark, #04-01/04, Singapore 119968

Phone: +65-6586-5500 FAX: +65-6271-7066

10F Posco Tower Yeoksam, Teheranro 134 Gangnam-gu, Seoul, 06235, Korea Phone: +82-2-3420-6695

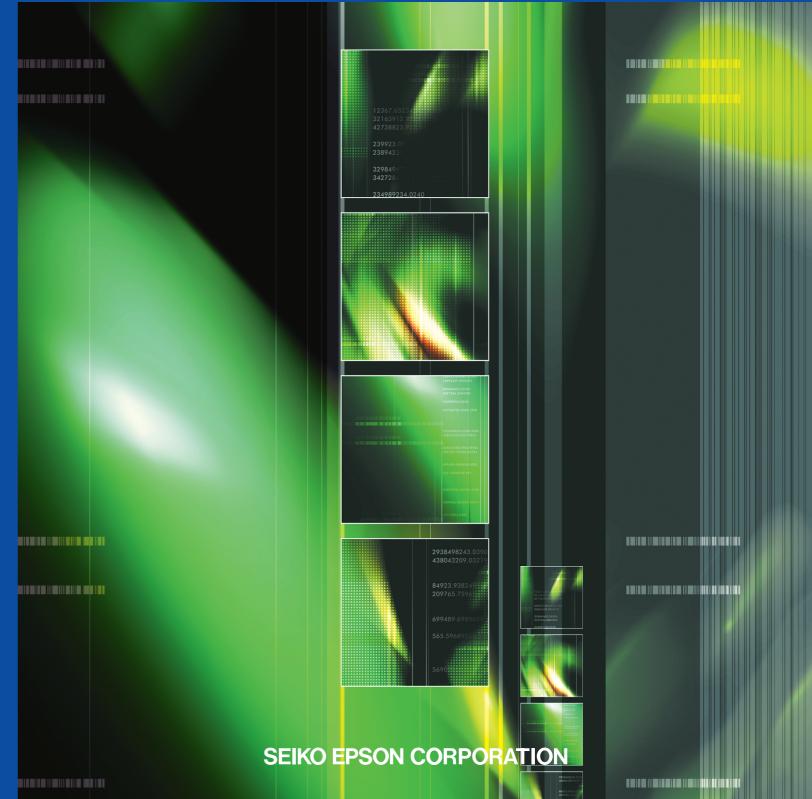
Seiko Epson Corp. **Sales & Marketing Division**

MD Sales & Marketing Department

JR Shinjuku Miraina Tower, 4-1-6 Shinjuku, Shinjuku-ku, Tokyo 160-8801, Japan

Microcontrollers

2023



Epson semiconductor website global.epson.com/products_and_drivers/semicon/

Document code : 701078830 First Issue April 2002 Revised March 2023 in JAPAN (F)

Business Concept

The widespread of smartphones and tablets make improvements of broadband and wireless communications, then the advanced information and telecommunications network society has become a reality. In particular, semiconductors for use in portable devices, information terminals, in-vehicle devices and FA devices are expected to provide higher performance in terms of thinner structure, lighter weight, and longer operation with limited power supply. We have been focusing on the creation of compact, low-power semiconductors since we started the development of CMOS LSI for watches in 1969. Since then, we have steadily built up our expertise in energy-saving, space-saving, and time-saving designs. This has enabled us to quickly obtain the semiconductor development technology needed to meet the demands of the new era of the advanced information and telecommunications network society. Our concept is to develop "saving technologies" to reduce power consumption, development times, and implementation space. Our goal is to be a true partner for you, providing you with strategic advantages, enhancing your customer value based on our "saving technologies" and mixed analog/digital technologies that we have cultivated, as well as our design capabilities, manufacturing capabilities and stable supply that can satisfy your detailed requirements.

Environmental Responsibility

Epson semiconductor technology provides environmental value to customers by creating and manufacturing eco-friendly products.

1) We Epson's products are surely complying with the Eu-RoHS (2011/65/EU) Directive.

2) We are releasing information about the containing chemical substances of products at web-site.

Product of QFP & BGA are described in the following URL.

global.epson.com/products_and_drivers/semicon/information/package_lineup.html *Some products are excluded.

Environmental management system third party certification status ISO14001

Type of certification: ISO 14001: 2015, JIS Q 14001: 2015

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION

(Fujimi Plant, Suwa Minami Plant)

Certified by : Bureau Veritas Japan Co., Ltd. Date of certification : April 3, 1999

Type of certification : ISO 14001: 2015

Awarded to: Singapore Epson Industrial Pte. Ltd. Certified by: SGS

Date of certification : Jan 12, 1999







Epson's Quality Policy

Keeping the customer in mind at all times, we make the quality of our products and services our highest priority. In oder to continue to creating products and services that please our customers and earn their trust. Epson's Semiconductor Business has acquired ISO9001 and IATF16949 certification with its IC, module and their application products.

Quality Management system third party certification status

Type of Certification: ISO9001: 2015, JIS Q 9001: 2015

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION

(Fujimi Plant, Suwa Minami Plant, Tokyo Office)

Certified by : Bureau Veritas Japan Co., Ltd.

Certificate No.: 3762381

Initial Date of Certification : October 10, 1993

Type of Certification: ISO9001: 2015

Awarded to: Singapore Epson Industrial Pte. Ltd.

Certified by: SGS

Certificate No.: SG03/00011

Initial Date of Certification : February 4, 2003

IATF16949

Type of Certification: IATF16949:2016

Awarded to: TOHOKU EPSON CORPORATION, SEIKO EPSON CORPORATION (Fujimi Plant, Tokyo Office), Epson Europe Electronics GmbH, Epson America,

Inc., Epson Canada Ltd.(Vancouver Design Center)

Certified by: Bureau Veritas Japan Co., Ltd.

Certificate No. : 281371

Initial Date of Certification: Dec 9, 2017

Type of Certification: IATF16949:2016

Awarded to : Singapore Epson Industrial Pte. Ltd. Certified by : SGS

Certificate No.: SG07/00021

Initial Date of Certification : May 2, 2018

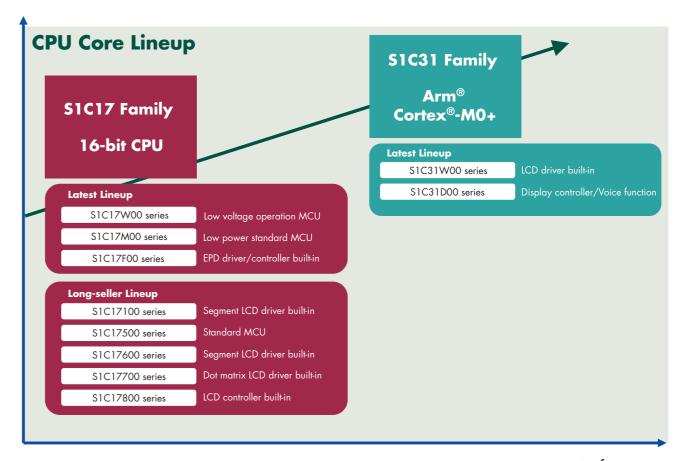












Performance

C O N T E N T S

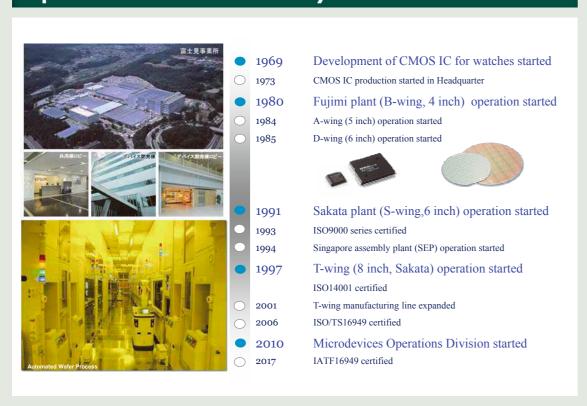
History of Epson semiconductor	4-5	Development environments	20-23
Epson microcontroller overview	6	Flash memory writing	24-25
Features of Epson microcontrollers	7-9	Package lineup	26-27
S1C31 Family Arm® microcontrollers	10-13	Epson MCU website	28-29
S1C17 Family 16-bit microcontrollers	14-19		

MCUs

MCUs History of Epson semiconductor

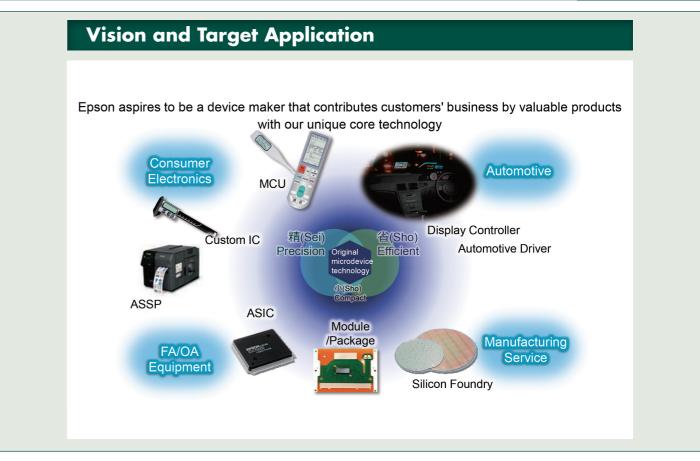
History of Epson Semiconductor's Technology As the semiconductor division of "worldwide watch maker Seiko", semiconductor business has expanded into LCD Drivers, ASICs and MCUs from IC for Watches. These businesses are all based on Epson's energy-saving technology. **LCD** Driver **LCD** Controller ASSP Microcontroller ASIC (G/A, E/A, S/C) - World first CMOS IC for digital watches with LCD display. (1973) Custom IC (Analog) - Low voltage operation CMOS IC for analog watches that consume less than 200nA. (1980) Silicon Foundry **Energy-Saving Technology**; Technology that reduces power consumption from both sides of process and circuit have been nurtured by Epson over 40 years since division was founded.

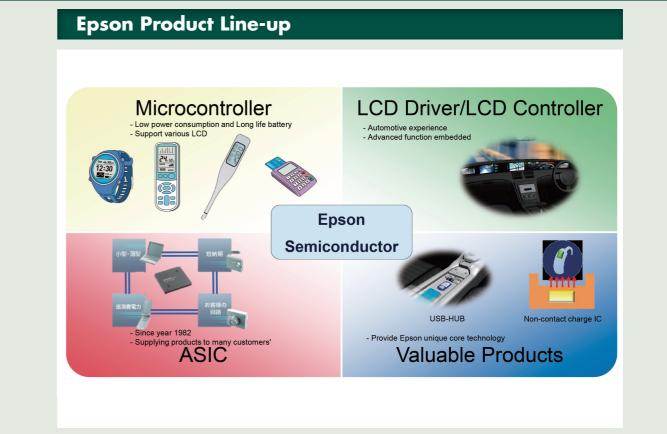
Epson Semiconductor's History



History of Epson semiconductor

MCUs





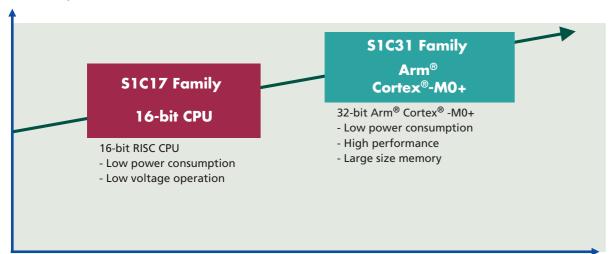
MCUs

Epson microcontroller overview

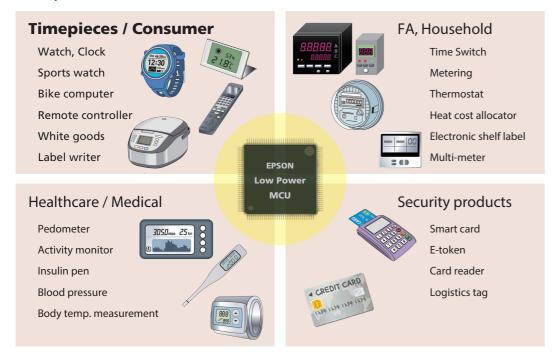
■ Low power microcontrollers

The technologies of low voltage operation and low power consumption acquired over the years through the development of 4-bit microcontrollers for watches and electronic shelf labels (ESL) are inherited by 16- and 32-bit microcontrollers today. The product lineup has been expanded, while achieving better throughputs. The display functions range from small-sized segment LDC drive to QVGA color display. A wide array of sensor interfaces recently attracting attention are also available. In addition to digital SIO such as SPI, UART, and I²C and the low power ADCs, the Epson original frequency conversion type ADC is capable of supporting measurements by resistance thermometer sensors and humidity sensors. A variety of these functions, low power technology and a highly efficient processor are all built into a single chip. With this one-chip solution, Epson continues to offer optimum products for small-sized battery-driven equipment, operation panel controllers, and sensor built-in healthcare products and housing equipment.

■ CPU Core Lineup



■ Application Example



Features of Epson microcontrollers

MCUs

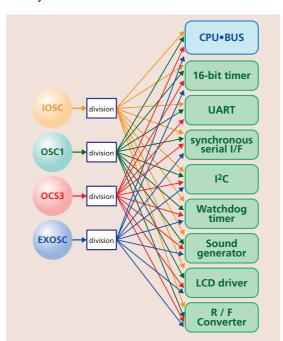
■ Lowest Current Consumption (16-bit microcontrollers)

In most cases, the S1C17 Family of products will allow customers currently using 8-bit microcontrollers to enjoy higher performance with the same power consumption. In addition, it will enable customers already using 16-bit/32-bit microcontrollers to benefit from longer battery life as a result of low operating voltage.



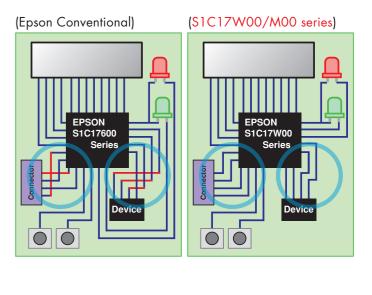
■ Four types of clock sources

Four types of characteristic clock sources can be freely selected for each circuit.



■ Terminals can be allocated freely (Universal Port Multiplexers)

SPI, I²C, UART, 16-bit PWM, and other terminals can be freely allocated as individual UPMUX terminals using software.



MCU

MCUs Features of Epson microcontrollers

Features of Epson microcontrollers

MCUs

■ Supporting various types of LCD

• Black & White LCD driver

- Segment LCD driver

- 12 to 88seg x 4/8com
- 1/3 bias LCD voltage booster built-in

- Dot Matrix LCD driver

- 56 to 128seg x 16/24/32/64com
- 1/4,1/5 bias LCD voltage booster built-in

Models containing Black & White LCD driver:

- S1C17W10 group
- S1C17W20 group
- S1C17W30 group
- S1C17M30 group
- S1C17M40 group
- S1C31W00 series

Built-in power supply circuit





Segment LCD



Dot matrix LCD



LCD controller

- STN/TFT LCD controller

- 320 x 240monochrome / 320 x 240 (QVGA)16gradations

- Memory display controller

- 300 x 300 6-bit color / 640 x 640 Black & White
- Supporting graphic engine function

Models containing LCD controller:

- S1C17800 series
- S1C31D00 series

Segment EPD driver

- 42 to 256seg + TP/BP
- Voltage booster built-in

Models containing EPD driver:

- S1C17F00 series

Segment LED driver

- 8seg x 5com supporting 5V

Models containing LED driver:

- S1C17M12/M13

Memory display



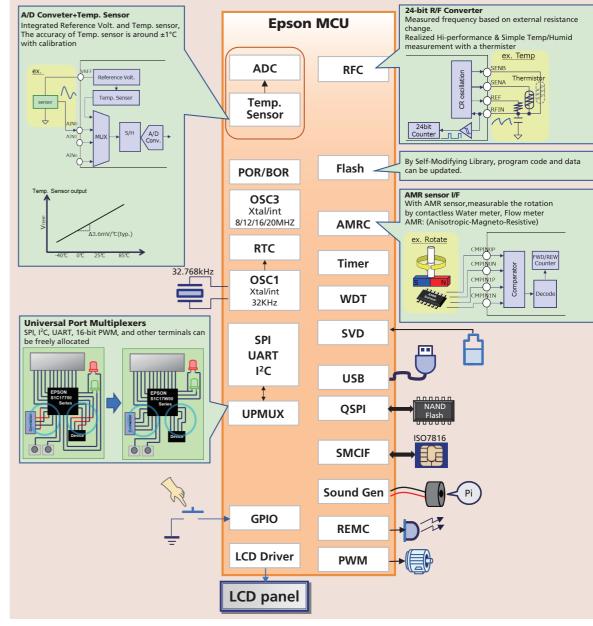
Segment EPD



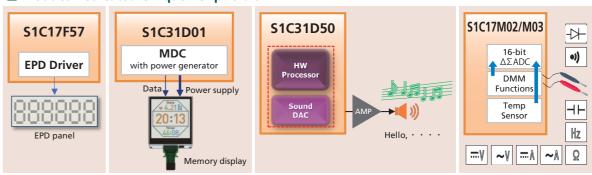
Segment LED



■ A large number of different types of interfaces are included



■ Product Dedicated Unique Peripherals



*: Peripheral circuits configured by products are different.

Suitable for wearable and industrial control devices Guaranteed 105°C operation Arm® microcontroller with LCD driver S1C31W00 Series *1

*1: S1C31W74 is -40°C to 85°C operation guarantee

■ General

The S1C31W00 series is 32-bit MCU with an Arm® Cortex®-M0+ processor included that features low-power operation. It has a guaranteed operating temperature up to 105°C, suitable for industrial applications. In addition, it integrates LCD driver (MAX.2,560-dot) and a lot of serial interface circuits.

Large capacity memory

Large capacity memory corresponding to market trend of multi functionality is integrated on a single chip. It is possible to store and operate user programs that size is increasing by complicated software design.

Suitable for diverse product environments

Considering the operating environment of industrial equipment, it guarantees operation from -40°C to 105°C without frequency or supply voltage limitations.

Built-in high resolution LCD driver

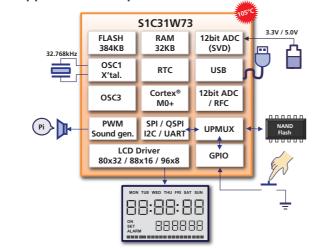
S1C31W series can drive dot-matrix or 7-segment LCD by built-in LCD driver. It equips internal constant voltage circuit that has been cultivated over the Epson traditional products, and can maintain display quality that is not affected by the remaining battery level. The contrast can be adjusted by software. It offers optimum and flexible design for user's product development.

Wide variety of interface

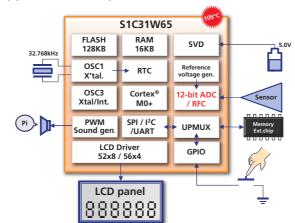
In addition to UART, SPI and I²C, it supports Quad-SPI (QSPI) which can communicate with external serial flash memory at high speed. An R/F converter for temperature and humidity measurement, USB FS 2.0 device controller, Universal port multiplexers that increase board layout design flexibility are also supported.

* It depends on the product which interface are supported.

■ Application example: Industrial controll device



■ Application example: Industrial control device



Arm® microcontroller with a memory display controller "\$1C31D01"

MCUs

■ General

The S1C31D01 is a 32-bit MCU with an Arm® Cortex®-M0+ processor included that features low-power operation.

It integrates a lot of serial interface circuit, a memory display controller, and a voltage booster.

Memory Display Controller (MDC)

MDC supports several panel interfaces for each memory display. It includes graphics hardware acceleration functions such as rotation of frame buffer image to panel, Image/bitmap copy with scaling/rotation/horizontal and vertical shearing/alpha-blending*, Line/Rectangle/Ellipse/Arc drawing with filled and unfilled.

It can contributs to reduce software load by dedicated hardware.

Power booster circuit

The S1C31D01 generates supply voltages for memory display (VMDH/ VMDL) with programmable power booster curcuit. It is possible to reduce external components.

Small size package

Wafer level Chip Size Package (WCSP) is supported as same size with chip. It is suitable for various applications which have limited mounting area on the print circuit board.

Lineup

Epson prepares CPU-less dedicated memory display controller "S1D13C00" for the customers who already have Host CPU. It supports same features with S1C31D01 about graphic accereration function and power booster circuit. There is a variety of products that can be selected according to your system.

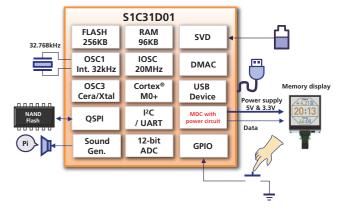
■ Examples of Graphic Acceleration Drawing Engine



Imge / Bitmap copy



■ Application Example: Sport watch



* Alpha-blending: supported at 6-bit color only

■ S1C31W00 Series Products overview

	Display		Operation clos	:k		Supply	current		Power	supply		Memory		I/O		Tim	ier				SIO				Analog		Res	et		Othe	ers	Form of deli	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [µA/MHz] (Typ.)	mode1 Operating [μΑ/ΜΗz] (Typ.)	Normal Operation [V]	Flash Programming [V]	Flash ROM [Byte]	Display RAM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	PC	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD	POR	BOR	Sound	USB	Special function	Package	Chip
S1C31W65	52 x 8 56 x 4	33M	32.768k	32k/1M/2M/ 8M/12M/16M/ 24M/32M	0.3	1.5	195	130	1.8 to 5.5	2.2 to 5.5	128K	112	16K	64	8	3 x 4	1	1	2	2	-	2	1	1	7	1	0	0	1	-	DMA	TQFP14-100	-
S1C31W73	96 x 16 88 x 24 80 x 32	33M	32.768k	32k/1M/2M/ 8M/12M/16M/ 24M/32M	0.7	2.0	214	150	1.8 to 5.5	2.2 to 5.5	384K	768	32K	73	8	2 x 4	1	1	2	2	1	2	1	1	7	1	0	0	1	1	DMA	QFP21-216	0
S1C31W74	88 x 16 80 x 24 72 x 32	21M	32.768k	1M/2M/8M/ 12M/16M/20M	0.4	1.7	250	150	1.8 to 3.6	2.4 to 3.6	512K	704	128K	71	4	2 x 2	1	1	2	1	1	2	1	1	-	2	0	0	1	1	-	VFBGA8H-181	0

■ S1C31D01/S1C31D00 Products overview

	Display		Operation clo	ock		Supply	current		Powe	r supply	Mer	mory	I/O		Tim	er				SIO			Analog		Re	set		Othe	ers	Form of de	elivery
Products	Display controller	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [µA/MHz] (Typ.)	mode1 Operating [µA/MHz] (Typ.)	Normal Operation [V]	Flash Programming [V]	Flash ROM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	I ² C Remote controller transmission and	R/F converter (24-bit)	A/D converter (12-bit)	SVD	POR	BOR	Sound	USB	Special function	Package	Chip
S1C31D01	MDC	21M	32.768k	32k/1M/2M/ 8M/12M/16M/20M	0.46	1.7	250	155	1.8 to 5.5	2.4 to 5.5	256K	96K	57	8	2 x 6	1	1	3	2	1	2 1	-	7	1	0	0	1	1	DMA	WCSP96 TQFP14-80 VERGA5H-81	0

■ S1D13C00 Products overview

3101300	o i roducts overvie	VV					
Products	CPU Interface Support	Panel Interface Support	Color Depth (Max.)	Internal Memory Capacity	Supply Voltage	Additional Features	Packege
S1D13C00F00C B00C	SPI, QSPI, Indirect 8-bit	6-bit color MIP, 3-bit or 1-bit Memory LCD with SPI	64 colors	96KB	1.8V to 5.5V	RTC, SPI, QSPI, I2C, DMAC, Sound Generator IR remote control transmitter	TQFP13-64 WCSP64

MCUs

N

/ICUs

ideal sound solution for home appliances and electronics

Arm® microcontroller with Dedicated Sound Hardware "S1C31D50/51/41"

■ General

The S1C31D50/51/41 is a 32-bit Arm® Cortex®-M0+ MCU which integrates a specific hardware block called the HW Processor.

The HW Processor can perform 2ch Voice/Audio Play. Voice Speed Conversion, and Self Memory Check without using any CPU resources.

A dedicated HW Processor provides 2-channel sound on a single MCU chip. The use of two channels enables music and voice to be played simultaneously. The audio guidance becomes more elegant and warmer.

Voice Speed Conversion

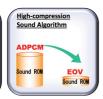
The speed of the easy-to-hear voice depends on the end user. This functuion enable to adjust the speed by the end user.

Buzzer Voice play(D51/D41)

By making it possible to output voice guidance sound like error and







warning messages on a buzzer instead of a speaker, the usability of the MCU is increased. Common buzzer sound output performance is often very poor because of low volume and limited bandwidth. Epson improved buzzer performance by using new development algorithm.

Pitch conversion(D41)

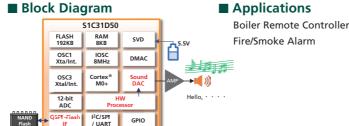
The pitch of the comfortable-to-hear voice depends on the end user. This functuion enable to adjust the speed by the end user.

High-compression Sound Algorithm

Epson high-compression algorithm(EOV) cultivated in Epson LSI business is inherited. For example, the data size of 1min voice at 15.625kHz sampling frequency is about 120KB. It is 1/4 size of the data created by

Self-Memory Check

HW processor can detect failures in built-in RAM, built-in Flash, and external SPI-Flash memories without using CPU resources.



■ Main Features

	S1C31D50	S1C31D51	S1C31D41
Flash	192KB(For Prog	gram and Sound)	96KB(For Program and Sound)
RAM	8KB +14KB HW Processor not active	10KB +12KB HW Processor not active	8KB +18KB HW Processor not active
HW Processor	2ch mixing play(ch0 and ch1) Voice Speed Conversion(only ch0) Voice Pitch Conversion(D41) Self Memory Check(On Chip RAM, On Chip F	lash, External SPI-Flash)	
Sound DAC	Sampling Frequency: 15.625kHz		
Serial Interface	SPI(3ch), UART(3ch), I2C(3ch), QSPI(1ch)		
Sound Play Method	AMP + Speaker		Speaker it + Speaker uit + Buzzer
ADC	12-bit (M	ax. 8-port)	12-bit (Max. 8-port, 1-port for temperature sensor
SVD	VDD: 28 levels (1.8V to 5.0V)/External voltage	e: 32 lavels (1.2V to 5.0V)	
DMA	4ch (Memory ⇔ Memory, Memory ⇔ Peripher	al)	
RFC	CR oscillation type 24-bit counters		
Timers	16-bit Timer (8ch), 16-bit PWM (2ch), WDT, I	RTC	
Power Supply	1.8V to 5.5V VDD 3.3V SPI-Flash Interface Power Supply		
Flash Programming	2.4V to 5.5V		2.2V to 5.5V
Clock Frequency	Max. 16MHz (internal power: 1.8V) Max. 1.8MHz (internal power: 1.2V)		TBD
Power Consumption	Standard Mode Low Power Mode RUN: 250µA/MHz (internal: RUN: 150µA/MHz (internal: SLEEP: 0.4µA, RTC mode: 0.9	1.2V) Max. 1.8MHz	TBD
Package	P-LQFP064 P-TQFP080	3-0707-0.50 -1010-0.50 -1212-0.50 -1414-0.50	P-TQFP032-0707-0.80 P-TQFP048-0707-0.50 P-LQFP064-1010-0.50
IEC-60730		supported by Sample SW	

12

User-Friendly Substantial Development Environment Voice Creation PC Tool, Simple sound play interface, easy sound data update in market



S1C31D50/51/41 Development Environment provides User-Friendly Substantial Development, this makes it easy to create natural voice data and play the sound.

■ Epson Voice Creation PC Tool

Using Epson Voice Creation PC Tool, natural voice data can be created by just PC, so no need to struggle studio recording, announce arrangement and additional cost. Typically only text input to the tool is enough to create the voice data. The tool also supports phrase combination, pronunciation adjust and importing existing WAV file a customer already has.

[Supported Languages]

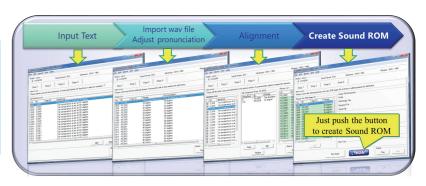
: Japanese, Chinese (Mandarin), Korean

America: American English, American Spanish,

Canadian French

Europe : British English, German, French, Spanish,

Italian, Russian



■ Link between Voice creation Tool and IC

Epson Voice Creation PC tool also makes it easy to develop firmware. A firmware engineer does not need to care phrase combination and delay among phrases etc, because all information is included in Sound ROM and Hardware Processor. By just setting the Sentence Number on the tool to IC register, the sound can be played.







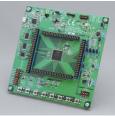


■ Evaluation Board

4 languages sound demo with melody is preset. Pushing the button on the evaluation board, 2ch mixing sound can be played.

Also customers can write new sound ROM Data from PC to this board and play own sound





	S1C31D5

■ Sound H	W MCUs																											S1C31D41		S1C31D50	
	Display		Operation clo	ock		Supply	current		Power	rsupply	Mer	mory	I/O		Tim	er				SIO			Analo	g	R	Reset		Oth	ers	Form of deli	livery
Products	Display controller	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	mode0 Operating [µA/MHz] (Typ.)	mode1 Operating [μΑ/ΜΗz] (Typ.)	Normal Operation [V]	Flash Programming [V]	Flash ROM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog	Real-time clock	UART	SPI	Quad SPI	I²C	Remote controller transmission and reception	converter (24-bit) A/D converter	(12-bit) SVD	POR	BOR	Sound	USB	Special function	Package	Chip
S1C31D50 / 51	-	16M	32.768k	32k/4M/8M/16M	0.46	1.8	250	155	1.8 to 5.5	2.4 to 5.5	192K	8K	39 55 71 91	8	2 x 4	1	1	3	3	1	3	1	1 5 7 8 8	1	0	0	-	-	DMA Sound HW	TQFP12-48 QFP13-64 TQFP14-80 QFP15-100	-
S1C31D41	-	16M	32.768k	32k/4M/8M/16M	0.34	1.5	215	130	1.8 to 5.5	2.2 to 5.5	96K	8K	25 39 55	8	2 x 4	1	1	3	3	1	3	1	1 6 7 8	1	0	0	-	-	DMA Sound HW	TQFP12-32 TQFP12-48 TQFP13-64	-

S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

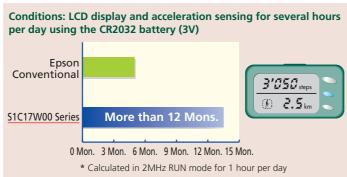
MCUs

■ World realized by low power consumption of the S1C17W00 Series



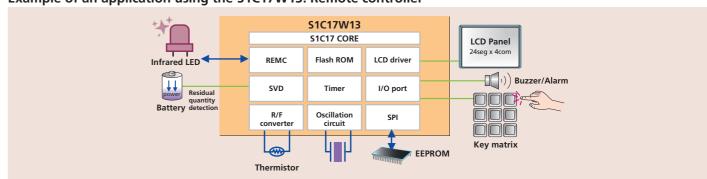
* Calculated in 32kHz RUN mode for 10m per second





■ S1C17W00 Series Application examples

Example of an application using the S1C17W13: Remote controller



15

■ S1C17W00 Series Products overview

	Display		Operation clock			Supply	current		Power supply	Men	nory	VO		Tir	ner				SIO				Analog			0	thers	Form of deliv	ivery
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	RAM [Byte]	I/O port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	QSPI	I²C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD *4	Sound	Multiplie r/Divider	Special function	Package	Chip
S1C17W00 series /	W00 group						le to low voltage o							highly efficacity of the						t voltage, t	o drive an I	IC with a lo	ow power o	consumpti	ion operation	on beyond	4-bit MCUs.		
S1C17W03	-	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	16K *3	2K	35 24	4	2 x 2	1	1	2	2	-	1	1	2*5 1	6 5	1	1	1	-	TQFP12-48 SQFN5-32	0 -
S1C17W04	-	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	32K *3	2K	35 24	4	2 x 2	1	1	2	2	-	1	1	2*5 1	6 5	1	1	1	-	TQFP12-48 SQFN5-32	0 -
S1C17W00 series /	W10/W20/W30 group						ole to low voltage of							d highly efficience					nal constan	it voltage,	to drive an	IC with a l	low power	consump	tion operat	tion beyond	d 4-bit MCUs. This prod	uct is equipped with a	built-in RTC
S1C17W12	26 x 4 18 x 4	4.2M	32.768k	32k/250k/ 384k/500k/ 700k/1M/	0.15	0.3	2	140	1.2 to 3.6	48K *3	2K	32 26	3	2 x 2	1	1	2	1	-	1	1	2 *5	-	1	1	1	LED pin x 2	- SQFN7-48	0
S1C17W13	26 x 4 18 x 4 20 x 4	4.2M	32.768k	2M/4M 32k/250k/ 384k/500k/ 700k/1M/ 2M/4M	0.15	0.3	2	140	1.2 to 3.6	48K *3	2K	32	3	2 x 2	1	1	2	1	-	1	1	2 *5	-	1	1	1	LED pin x 2	QFP13-64 SQFN7-48 TQFP12-48	0
S1C17W14	*7 54 x 4 50 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	3	200	1.2 to 3.6	48K *3	4K	33	3	2 x 2	1	1	2	2	-	1	1	1	-	1	1	1	-	QFP15-100	0
S1C17W15	34 x 4 30 x 8 32 x 4 28 x 8 24 x 4 20 x 8	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4 8	250	1.2 to 3.6	64K *3	4K	36 33 28	3	2 x 2	1	1	2	1	-	1	-	4 *5	-	1	1	1	-	QFP15-100 TQFP14-80 SQFN9-64 TQFP13-64	0
S1C17W16	60 x 4 56 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	3	200	1.2 to 3.6	64K *3	8K	40	5	2 x 2	1	1	2	3	-	1	1	2	4	1	1	1	-	TQFP15-128	0
S1C17W18	48 x 4 44 x 8 32 x 4 28 x 8 24 x 4 20 x 8	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.3	2	140	1.2 to 3.6	128K (*3)	8K	68 59 49	4	3 x 2	1	1	2	2	-	1	1	2 *5	7	1	1	1	Temperature sensor	TQFP15-128 TQFP14-80 SQFN9-64	0
S1C17W22	72 x 4/8 64 x 16 56 x 24	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	64K *3	4K	42	2	2 x 2	1	1	1	1	-	1	1	2	-	1	1	1	-	TQFP15-128	0
S1C17W23	72 x 4/8 64 x 16 56 x 24	4.2M	32.768k	500k/700k/ 1M/2M/4M	0.15	0.3	4	250	1.2 to 3.6	96K *3	8K	42	4	3 x 2	1	1	2	2	-	1	1	2	6	1	1	1	-	TQFP15-128	0
S1C17W34	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6 *2,*6	128K (*3)	12K	53	4	3 x 2	1	3	2	2	-	1	1	2	7	1	1	1	Temperature sensor	QFP21-176	0
S1C17W35	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6 *2,*6	256K (*3)	12K	53	4	3 x 2	1	3	2	2	-	1	1	2	7	1	1	1	Temperature sensor	QFP21-176	0
S1C17W36	80 x 16 64 x 32	4.2M	32.768k	250k/384k/ 500k/700k/ 1M/2M/4M	0.15	0.4	3	150	1.2 to 3.6 *2, *6	384K (*3)	16K	53	4	3 x 2	1	3	2	2	-	1	1	2	7	1	1	1	Temperature sensor	QFP21-176	0

^{*1:} During erasing / programming in flash memory (VDD): 1.8V to 3.6 V

^{*2:} During operations LCD (VDD): 2.5V to 3.6V

^{*3:} During erasing / programming voltage in flash memory (VPP): The external applying of 7.5V / 7.5V (Typ.) is needed. (*3) can be rewritten even with internal power supply.

^{*4:} SVD is an abbreviation for Supply Voltage Detector.

^{*6:} During erasing / programming in flash memory (VDD): 2.4V to 3.6V

^{*5:} Independent operation for each channel.

^{*7:} External voltage application mode only. *8: Including Input port and Output port.

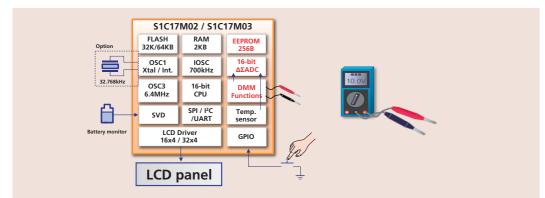
S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

MCUs

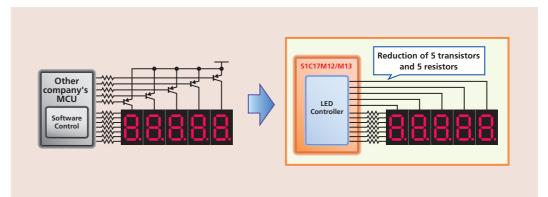
■ S1C17M00 Series Application examples

Example of an application using the S1C17M02/03: Digital Multimeter



■ S1C17M00 Series Function introduction

Example of 7 seg LED lighting up using the S1C17M12/M13



■ S1C17M00 Series Products overview

	Disp	lay		Operation clo	ck		Supply	current		Power supply		Memory		I/O		Tin	ner				SIO				Analog		Re	set		Oth	ers	Form of del	ivery
Products	LCD Driver seg×com	Display controller	High- speed [Hz] (Max.)	Low- speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	EEPROM [Byte]	RAM [Byte]	VO port	16-bit timer	16-bit PWM timer	Watchdog timer	Real-time clock	UART	SPI	Quad SPI	I ² C	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (12-bit)	SVD*4	POR	BOR	Sound	Multiplie r/Divider	Special function	Package	Chip
S1C17M00 series		It is an application supporting po	ation specializ	ed series. It is oltages from 1	a 16-bit MCU v 1.8 V to 5.5 V. (vith Flash mem S1C17M02/M0	ory compatible 3 are excluded	e with high pro d)	ocessing while	achieving low	power consum	ption,																					
S1C17M01	32 x 4 28 x 8	-	16.3M	32.768k	7.37M	0.35	0.8	12.5	210	1.8 to 5.5	32K *3	-	4K	19	5	-	1	1	1	2	-	1	-	1	-	1	0	-	-	-	AMRC	TQFP13-64	0
S1C17M02	16 x 4	-	6.4M	32.768k	32k/700k/ 3.2M/6.4M	0.24	0.9	5	-	2.1 to 3.6	32K (*3)	256	2K	19	4	-	1	-	1	1	-	1	-	-	-	1	0	0	1		Measurement function for DMM (Sigma delta type AD converter)	QFP13-64	-
S1C17M03	32 x 4	-	6.4M	32.768k	32k/700k/ 3.2M/6.4M	0.24	0.9	5	-	2.1 to 3.6	64K (*3)	256	2K	43	4	-	1	-	1	1	-	1	-	-	-	1	0	0	1		Measurement function for DMM (Sigma delta type AD converter)	QFP15-100	-
S1C17M10	88 x 8 80 x 16	-	16M	32.768k	32k/ 4M/8M/ 12M/16M	0.16	0.6	4	145	1.8 to 5.5	64K (*3)	-	4K	33	5	1 x 2	1	1	1	1	-	1	-	-	-	1	0	-	-	1	SMCIF	TQFP15-128	0
S1C17M12	-	LED controller 8x5	16.8M	-	4M/8M/ 12M/16M	0.35	40	-	150	1.8 to 5.5	16K *3	-	2K	39	4	1 x 2	1	-	1	2	-	1	1	-	-	1	0	0	-	1	High current port x 5	TQFP12-48	0
S1C17M13	-	LED controller 8x5	16.8M	-	4M/8M/ 12M/16M	0.35	40	-	150	1.8 to 5.5	16K *3	-	2K	39	4	1 x 2	1	-	1	2	-	1	1	-	8	1	0	0	-	1	High current port x 5	TQFP12-48	0
S1C17M20	-	-	21M	- 32.768k	32k/700k/ 12M/16M/20N	0.36	1.5 0.7	5.5 5	160	1.8 to 5.5	16K (*3)	-	2K	18 24	4	2 x 2	1	1	2	2	-	1	1	-	4 6	1	0	0	1	1	-	SQFN4-24 SQFN5-32	-
S1C17M21	-	-	21M	32.768k	32k/700k/ 12M/16M/20N	0.36	0.7	5	160	1.8 to 5.5	16K (*3)	-	2K	24	4	2 x 2	1	1	2	2	-	1	1	-	6	1	0	0	1	1	-	TQFP12-32	-
S1C17M22	-	-	21M	32.768k	32k/700k/ 12M/16M/20N	0.36	0.7	5	160	1.8 to 5.5	16K (*3)	-	2K	40	4	2 x 2	1	1	2	2	-	1	1	2	8	1	0	0	1	1	-	TQFP12-48	-
S1C17M23	-	-	21M	- 32.768k	32k/700k/ 12M/16M/20N	0.36	1.5 0.7	5.5 5	160	1.8 to 5.5	32K (*3)	-	2K	18 24	4	2 x 2	1	1	2	2	-	1	1	-	4 6	1	0	0	1	1	-	SQFN4-24 SQFN5-32	-
S1C17M24	-	-	21M	32.768k	32k/700k/ 12M/16M/20N	0.36	0.7	5	160	1.8 to 5.5	32K (*3)	-	2K	24	4	2 x 2	1	1	2	2	-	1	1	-	6	1	0	0	1	1	-	TQFP12-32	-
S1C17M25	-	-	21M	32.768k	32k/700k/ 12M/16M/20N	0.36	0.7	5	160	1.8 to 5.5	32K (*3)	-	2K	40	4	2 x 2	1	1	2	2	-	1	1	2	8	1	0	0	1	1	-	TQFP12-48	-
S1C17M30	26 x 4 22 x 8 *6	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	48K (*3)	256 *8	4K	38	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP12-48	-
S1C17M31	26 x 4 22 x 8	-	16.8M	-	32k/700k/ 12M/16M	0.2	1.4	5.5	160	1.8 to 5.5	48K (*3)	256 *8	4K	38	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP12-48	-
S1C17M32	42 x 4 38 x 8 *6	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	64K (*3)	256 *8	4K	54	4	3 x 2	1	1	2	2	-	1	1	2	2	1	0	0	1	1	-	TQFP13-64	-
S1C17M33	50 x 4 46 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	96K (*3)	32 to 512	4K	66	4	3 x 2	1	1	2	2	-	1	1	2	5	1	0	0	1	1	-	TQFP14-80	0
S1C17M34	37 x 4 33 x 8	-	16.8M	32.768k	32k/700k/ 12M/16M	0.2	0.7	5	160	1.8 to 5.5	64K (*3)	256 *8	4K	52	4	3 x 2	1	1	2	2	-	1	1	2	5	1	0	0	1	1	-	TQFP13-64	-
	40 x 4 36 x 8	-	16.8M	32.768k	32k/700k/ 16M	0.25	0.7	5	-	1.8 to 5.5	48K (*3)	256	2K	55	4	3 x 2	1	1	3	2	-	1	1	-	4	1	0	0	1	1	-	QFP13-64	-
S1C17M40	28 x 4 24 x 8	-	16.8M	-	32k/700k/ 16M	0.25	1.4	5.5	-	1.8 to 5.5	48K (*3)	256	2K	41	4	3 x 2	1	1	3	2	-	1	1	-	3	1	0	0	1	1	-	TQFP12-48	-

^{*1:} During erasing / programming in flash memory /EEPROM programming (VoD): 2.2V to 5.5V *2: During erasing / programming in flash memory / EEPROM programming / Analog circuit operation (VoD): 2.2V to 3.6V

^{*3:} During erasing / programming voltage in flash memory (VPP): The external applying of 7.5V / 7.5V (Typ.) is needed. (*3) can be rewritten even with internal power supply.

^{*4:} SVD is an abbreviation for Supply Voltage Detector. *5: Output dedicated port 1 included. *6: External voltage application mode only. to 5.5V

^{*7: (}MR sensor controller) Operation (V_{DD}) : 2.0V to 5.5V *8: AMRC Flash area is used.

^{*9:} During erasing / programming in flash memory (VDD): 2.4V to 5.5V

S1C17 Family 16-bit microcontrollers

S1C17 Family 16-bit microcontrollers

MCUs

■ S1C17 Long-running Series

	Display		Operation clock	K		Supp	ly current		Power supply		Memory		I/O				Timer						SIO			A	Analog			Others		Form of deli	very
Products	LCD Driver seg×com	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	Halt [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz Operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	Mask ROM [Byte]	RAM [Byte]	I/O port	8-bit timer	16-bit timer	16-bit PWM timer	Stopwatch	Watchdog timer	Clock	Real-time clock	UART	SPI	I²C master	l²C slave	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter (10-bit)	SVD *5	Sound generator	Multiplier /Divider	Special function	Package	C
S1C17100/600 seri	es						nd development er uit, clock function							n's 4/8-bit thcare dev																			
S1C17153	32 x 4	-	32.768k	500k/1M/2M	0.13	0.42	4	160	2.0 to 3.6	-	16K	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	-	(
S1C17651	20 x 4	4.2M	32.768k	32k/500k/ 1M/2M	0.09	0.42	10	350	2.0 to 3.6	16K *3	-	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	TQFP13-64	(
S1C17653	32 x 4	4.2M	32.768k	32k/500k/ 1M/2M	0.09	0.42	10	350	2.0 to 3.6	16K *3	-	2K	12	1	-	1	-	1	1	1	1	1	-	-	-	-	-	1	1	1	-	TQFP14-80	(
S1C17656	32 x 4	-	32.768k	500k/ 1M/2M/4M	0.13	0.5	7.3	280	1.8 to 3.6	24K *4	-	2K	20	1	-	1	-	1	1	1	1	1	-	_	-	1	-	1	1	1	-	TQFP14-80	
S1C17611	12 x 4 8 x 8	8.2M	32.768k	2.7M	0.6	2.0	12	400	1.8 to 3.6	32K *6	-	2K	19	2	3	2	1	1	1	-	1	1	1	1	-	1	4	1	-	1	-	QFP12-48	
S1C17601	20 x 4 16 x 8	8.2M	32.768k	2.7M	0.6	2.0	12	340	1.8 to 3.6	32K *6	-	2K	24	2	3	2	1	1	1	-	1	1	1	1	-	1	4	1	-	1	-	TQFP13-64	
S1C17621	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.5	15	410	1.8 to 3.6	32K *6	-	2K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
S1C17602	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.5	15	410	1.8 to 3.6	64K *6	-	4K	36	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP14-100	
S1C17622	56 x 4 52 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	64K *6	-	4K	47	3	3	1	1	1	1	-	2	1	1	1	1	2	8	1	-	1	-	TQFP15-128	
S1C17604	40 x 4 36 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	128K	-	8K	36	3	3	3	1	1	1	1	2	1	1	1	1	2	8	1	_	1	-	TQFP14-100	C
S1C17624	56 x 4 52 x 8	8.2M	32.768k	2.7M	0.75	2.3	14	400	1.8 to 3.6	128K	-	8K	47	3	3	3	1	1	1	1	2	1	1	1	1	2	8	1	-	1	-	TQFP15-128	C
S1C17500 series	32 7 0	[Low Power]	This is a 16-bit	t MCU with built-	in flash memo	ry, which real	izes high-speed pr	ocessing at lov	w power consum	nption. This prod	duct is equipped	with various	featur	es, such a	s a genera	al-purpose	VO port,	A/D conve	erter inpu	it and serial	l I/F, and i	s suitable	for cont	rolling vari	ious sensor	r built-in d	devices, in	cluding h	ousehold	appliance	2S.		
				414/914/						4201			88														16					QFP15-100	C
S1C17589	-	16.8M	32.768k	4M/8M/ 12M/16M	0.2	0.6	9	280	1.8 to 5.5	128K *4	-	16K	68 52	-	6	4 x 6	-	1	-	1	3	2	1	1	1	-	7	1	1	-	-	QFP14-80 QFP13-64	-
S1C17700 series				ed series. It is a 1 oltages from 1.8		h Flash memo	ory compatible wit	h high process	ing while achiev	ing low power o	consumption,																						
S1C17711	64 x 16 56 x 24	8.2M	32.768k	2.7M	1.0	2.0	12	400	1.8 to 3.6	64K *6	-	4K	29	-	4	4	1	1	1	-	1	1	1	1	1	2	8	1	-	1	-	TQFP15-128	C
S1C17702	88 x 16 72 x 32	8.2M	32.768k	2.7M	1.0	2.5	16	450	1.8 to 3.6	128K *6	-	12K	28	3	3	2	1	1	1	-	1	1	1	-	1	-	-	1	-	1	-	QFP21-176 VFBGA10H-180 VFBGA8H-181	C
S1C17703	120 x 16/24/32 60 x 64	8.2M	32.768k	2.7M	1.0	2.5	15	450	1.8 to 3.6	256K *6	-	12K	34	-	5	4	1	1	1	-	2	3	1	1	1	2	8	1	-	1	-	QFP21-216 VFBGA10H-240	
S1C17705	128 x 16/24/32 64 x 64	8.2M	32.768k	2.7M	1.2	2.7	18	550	1.8 to 3.6	512K *6	-	12K	35	-	5	4	1	1	1	-	2	3	1	1	1	2	8	1	-	1	-	VFBGA10H-240	С
S1C17800 series				-bit MCU realized provides maximu			alent to 32-bit. ys. This product is	equipped with	abundant built	-in I/F, such as U	SB, various seria	l interfaces	and A	/D conver	ters, suita	ble for ope	eration pa	anel contro	ol of whit	e home ap	pliances a	and variou	us produc	cts, with in	mproved us	ser interfa	ce utilizin	g displays	s, music, s	ound, tou	uch panels and	d etc.	
S1C17803	LCD Controllers	33M	32.768k	_	1.3	5	_	6500	2.7 to 5.5	128K *6	_	16K	97 69	4		2				1											US supported	TOFP15-128	

^{*11:} The battery backed up operation is supported.
*12: Universal serial interface (Any of UART, SPI and I²C functions can be selected.)

	Display		Operation cloc	k		Supply	current		Power supply		Memory		I/O				Timer						SIO				Analog		Oth	ners	Form of deliv	very
Products	EPD Driver seg (TP/BP)	High-speed [Hz] (Max.)	Low-speed [Hz] (Typ.)	Built-in oscillator [Hz] (Typ.)	Sleep [µA] (Typ.)	RTC [µA] (Typ.)	32kHz Operating [µA] (Typ.)	1MHz operating [µA] (Typ.)	Supply voltage [V]	Flash ROM [Byte]	EEPROM [Byte]	RAM [Byte]	I/O port	8-bit timer	16-bit timer	16bit-PWM timer	Stopwatch	Watchdog timer	Clock	Real-time clock	UART	SPI	I ² C master	I²C slave	Remote controller transmission and reception	R/F converter (24-bit)	A/D converter	SVD*1	Multiplier/Divider	Temparature detection circuit	Package	Chip
S1C17F50 series		[Medium and maximize the	small segment EF characteristics of	D] The product als	o includes embe	edded features su p.	uch as a real-time	clock, theoretica	l regulation, a drive	capable of wri	nging the maxin	num	perfo	rmance fr	om segme	ented EPDs	, and a tem	nperature s	sensor. As	a result,	the device	does not s	imply drive	the disp	play, but al	so correct	ts tempera	ture effect	s that cou	ıld harm dis	play quality making it	possible to
S1C17F57	64 (2TP/2BP)	4.2M	32.768k	32k/500k/1M/2M	0.10	0.21	12	410	2.0 to 3.6	32K*2	-	2K	29	2	-	2	1	1	1	1	1	1	1	1	-	1	-	1	1	1	-	O *3
S1C17F63	42 (1TP/1BP)	16.8M	32.768k	500k/700k/1M/ 2M/4M/8M/16M	0.45	0.11	5	305	1.8 to 5.5*5	32K ^(*2)	256	2K	17	-	4	2 x 2	-	1	-	1	1	2	1		-	-	7	1	1	1	QFP15-100	O *3

^{*1:} SVD is an abbreviation for Supply Voltage Detector.

^{*1:} During erasing / programming in flash memory (Vbb): 2.7V to 3.6 V
*2: During erasing / programming in flash memory (Vbb): 2.5V to 3.6 V
*3: During erasing / programming voltage in flash memory (VPP): The external applying of 7.5V / 7.0V (Typ.) is needed.

^{*4:} During erasing / programming voltage in flash memory (Vpp): The external applying of 7.5V / 7.5V (Typ.) is needed. *5: SVD is an abbreviation for Supply Voltage Detector. *6: This product uses SuperFlash® technology licensed from SST UK Ltd.

^{*7:} Al pad, Au bump

^{*8:} Including Input port and Output port. *9: Resolution: 12-bit

^{*2:} During erasing / programming voltage in flash memory (Vpp) : The external applying of 7.0V / 7.5V (Typ.) is needed. (*2) can be rewritten even with internal power supply.

^{*3:} Al pad, Au bump

^{*4:} Including Input port and Output port.

^{*5:} During erasing / programming in flash memory /EEPROM programming (VDD) : 2.2V to 5.5V

Development environments - S1C31 Family -

Development environments - S1C31 Family -

MCUs

■ Overall development environment



■ Development support tool (Evaluation board)

- S1C31 chip built in
- Possible to evaluate the IC functions
- Provides a sample sources for various functions
- Debugging and Flash programming supported









SVT31D01

SVTmini31W65

SVT31W74





SVT31D50



Model Name	Product Name	Mounted Microcontroller Name	Remarks
SVTmini31W65	S5U1C31W65T2	S1C31W65	
SVTmini31W73	S5U1C31W73T2	S1C31W73	
SVT31W74	S5U1C31W74T1	S1C31W74	Dot matrix liquid crystal panel, Infrared LED, USB connector, Bridge Board
SVT31D01	S5U1C31D01T1	S1C31D01	Color memory display, Acceleration gyro sensor, Pulse sensor, Bridge Board
SVT31D50	S5U1C31D50T1	S1C31D50	AMP(class AB, class D), SPI-FLASH(8MB)
SVT13C00	S5U13C00K00C	S1D13C00	Color memory display, Bridge Board for connecting to Host CPU

■ 3rd Party tool inquiries

Integrated Development Environment, Debug Probe



IAR Systems K.K. www.iar.com/buy/

SEGGER Microcontroller GmbH www.segger.com

21

Development environments - S1C17 Family -

GNU17 package

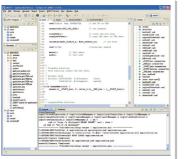
Optimized C compiler supporting 16MB space Assembler, linker and **ANSI library** GUI-based debugger Eclipse integrated environment



On-chip ICE, S1C17 Family products are supported. Connect with the target board with 4 pins at minimum (3 signal pins and 1 GND pin). Includes execution time measurement function. Uses USB bus power.

Can be used as a Multi Programmer. Includes firmware update function.

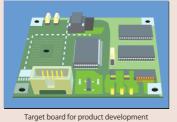
Power supply function for target devices of 3.3V.



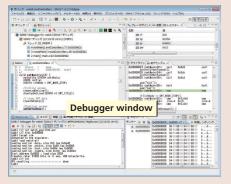








■ Development support tool (Software simulator)





22

10-line cable (DCLK, DSIO, DST2, GND)

- •Simulatable on PC including the LCD display, without using external debugging hardware or using an actual chip, it is possible to simulate only the LCD display (Custom-made LCD Panels can be created)
- •Ability to show various data at the same time in multiple windows
- •Ability to execute frequently using commands from the tool bar or menus
- Function of displaying C source, program code and symbols using disassembler
- Consecutive program execution and 3 types of step executions
- •3 types of break functions
- Trace and coverage functions
- Automatic command execution using command files

Development environments - S1C17 Family -

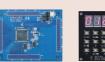
MCUs

■ Development support tool (Evaluation board)

SVTmini17F57

- S1C17 chip built in
- Possible to evaluate the IC functions
- Provides a sample software for various functions
- Debugging and Flash programming supported

SVT17F57





SVTmini17F63









SVTmini17W04 SVTmini17W12

SVT17M01



SVT17W23



SVTmini17W13

SVTmini17M40



SVTmini17W14



SVTmini17W15



SVTmini17W16







S5U1C17F57T11

3711/13/	3301017F37111	31017537	Segment Erb panel
SVTmini17F57	S5U1C17F57T21	S1C17F57	
SVTmini17F63	S5U1C17F63T21	S1C17F63	Segment EPD panel
SVT17M01	S5U1C17M01T11	S1C17M01	LCD panel, MR Sensor with EEPROM
SVT17M03	S5U1C17M03T11	S1C17M03	Digital multimeter referrence board
SVTmini17M10	S5U1C17M10T21	S1C17M10	
SVT17M13	S5U1C17M13T11	S1C17M13	7 seg LED 5 digits, EEPROM, Infrared LED, Key matrix 3x4
SVTmini17M25	S5U1C17M25T21	S1C17M25	
SVT17M33	S5U1C17M33T11	S1C17M33	Reference board of remote controller
SVTmini17M33	S5U1C17M33T21	S1C17M33	
SVTmini17M40	S5U1C17M40T21	S1C17M40	
SVTmini17M13	S5U1C17M13T21	S1C17M13	
SVTmini17W04	S5U1C17W04T21	S1C17W04	
SVTmini17W12	S5U1C17W12T21	S1C17W12	
SVTmini17W13	S5U1C17W13T21	S1C17W13	
SVTmini17W14	S5U1C17W14T21	S1C17W14	
SVTmini17W15	S5U1C17W15T21	S1C17W15	
SVTmini17W16	S5U1C17W16T21	S1C17W16	
SVTmini17W18	S5U1C17W18T21	S1C17W18	
SVT17W23	S5U1C17W23T11	S1C17W23	LCD panel, Piezoelectric buzzer
SVTmini17W36	S5U1C17W36T21	S1C17W36	
SVTmini17589	S5U1C17589T21	S1C17589	
SVT17602	S5U1C17602T11	S1C17602	LCD panel, Remote control transmitter and receiver, Thermal/Humidity/Illuminance sensor
SVTmini17611	S5U1C17611T21	S1C17611	
SVT17656	S5U1C17656T11	S1C17656	LCD panel, Capacitive touch button, Piezoelectric buzzer
SVTmini17656	S5U1C17656T21	S1C17656	
SVT17702	S5U1C17702T11	S1C17702	LCD panel, Remote control transmitter and receiver

MCUs 23

SVTmini17803

S5U1C17803T21

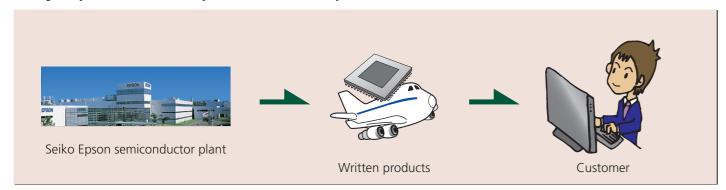
S1C17803

MCUs Flash memory writing

Flash memory writing

MCUs

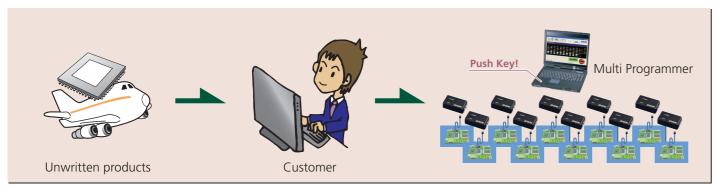
■ If you procure written products from a Epson dealer

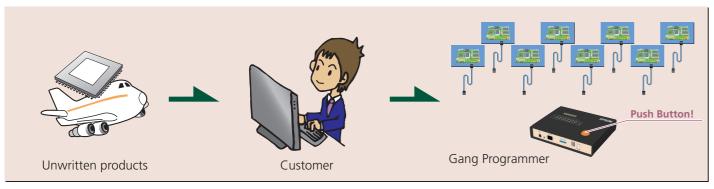


■ If you write to flash memory on your side (Single writing)



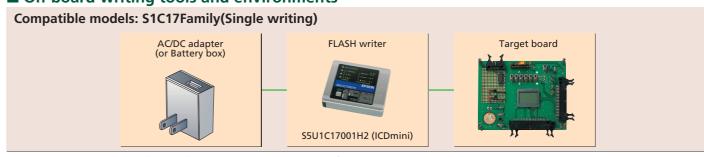
■ If you write to flash memory on your side (Simultaneous multiple writing)



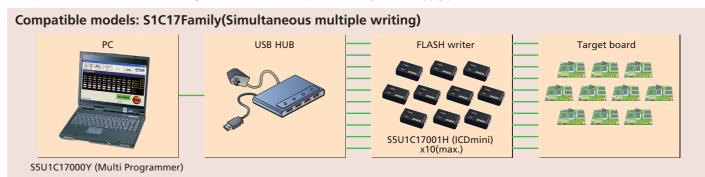


24

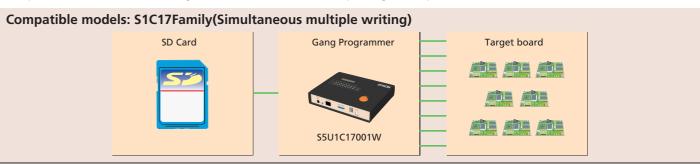
On-board writing tools and environments



- A single S5U1C17001H2 (ICDmini) unit operates as an on-chip flash writer. Simply by pressing a button, user data previously saved in the ICDmini can be written to the internal flash ROM on the target board, or the flash ROM connected to the external bus.
- You can enjoy on-board programming easily at any location where a 5V power supply is available
- * Power supply to the target board may be required separately.
- * The product does not include the target board, and AC adapter or battery box to supply power to USB terminals.



- Up to 10 units of the S5U1C17001H (ICDmini) can be used to construct an environment enabling user data to be downloaded simultaneously to multiple targets.
- The S5U1C17000Y, Multi Programmer software that controls the ICDmini, provides user-friendly screen and simple operation.
- * Power supply to the target board may be required separately.
- * The product does not include the target board, PC and the USB hub operating on self-power



- A single S5U1C1700W unit downloads user data simultaneously to maximum 8 targets.
- SD card is used to input user data, and the operating status can be checked by LCD, LED and buzzer.
- A serial number writing function is also built-in.



• SEGGER J-Link or Flasher / Any debug probe or flash programmer that supports J-Flash software tool can be used.

MCUs Package lineup

Package lineup

MCUs

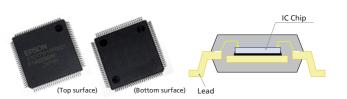
■ QFP & TQFP & SQFN

PKG type/Pin count	Body size (mm)	Lead pitch (mm)
SQFN4-24 (P-VQFN024-0404-0.50)	4 X 4 X 1.0	0.5
SQFN5-32 (P-VQFN032-0505-0.50)	5 X 5 X 1.0	0.5
TQFP12-32 (P-TQFP032-0707-0.80)	7 X 7 X 1.2	0.8
QFP12-48 (P-LQFP048-0707-0.50)	7 X 7 X 1.7	0.5
SQFN7-48 (P-VQFN048-0707-0.50)	7 X 7 X 1.0	0.5
TQFP12-48 (P-TQFP048-0707-0.50)	7 X 7 X 1.2	0.5
SQFN9-64 (P-VQFN064-0909-0.50)	9 X 9 X 1.0	0.5
QFP13-64 (P-LQFP064-1010-0.50)	10 X 10 X 1.7	0.5
TQFP13-64 (P-TQFP064-1010-0.50)	10 X 10 X 1.2	0.5
TQFP14-80 (P-TQFP080-1212-0.50)	12 X 12 X 1.2	0.5
QFP14-80 (P-LQFP080-1212-0.50)	12 X 12 X 1.7	0.5

DVG : 101	Body size	Lead pitch
QFP15-100 (P-LQFP100-1414-0.50)	(mm)	(mm)
TQFP14-100 (P-TQFP100-1212-0.40)	12 X 12 X 1.2	0.4
TQFP15-128 (P-TQFP128-1414-0.40)	14 X 14 X 1.2	0.4
QFP21-176 (P-LQFP176-2424-0.50)	24 X 24 X 1.7	0.5
QFP21-216 (P-LQFP216-2424-0.40)	24 X 24 X 1.7	0.4

■ WCSP

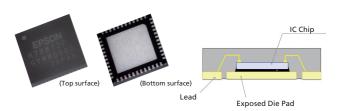
PKG type/Pin count	Body size (mm)	Ball pitch (mm)
WCSP-96 (S1C31D01)	4.45 X 4.45 X 0.7	0.4



■ Compact BGA (PFBGA) & Thin type BGA (VFBGA)

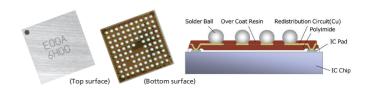
PKG type/Pin count	Body size (mm)	Ball pitch (mm)
VFBGA5H-81 (P-VFBGA-081-0505-0.50)	5 X 5 X 1.0	0.5
VFBGA10H-180 (P-VFBGA-180-1010-0.65)	10 X 10 X 1.0	0.65
VFBGA8H-181 (P-VFBGA-181-0808-0.50)	8 X 8 X 1.0	0.5
VFBGA10H-240 (P-VFBGA-240-1010-0.50)	10 X 10 X 1.0	0.5

SQFN

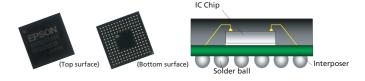


WCSP

27



Thin type BGA (VFBGA)

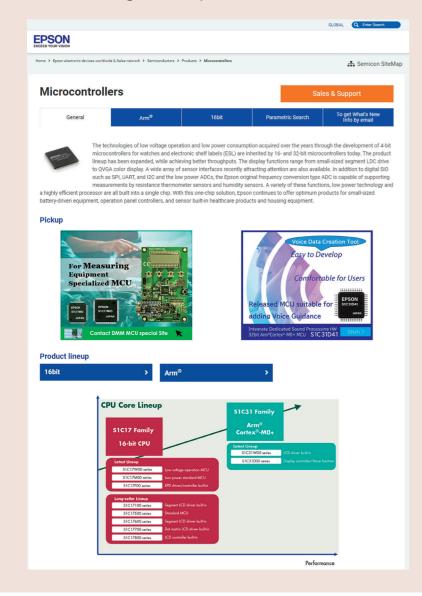


Epson MCU website

Epson MCU website

global.epson.com/products_and_drivers/semicon/products/micro_controller/

On the Epson MCU website, you can access a variety of information required for device selection and design development.



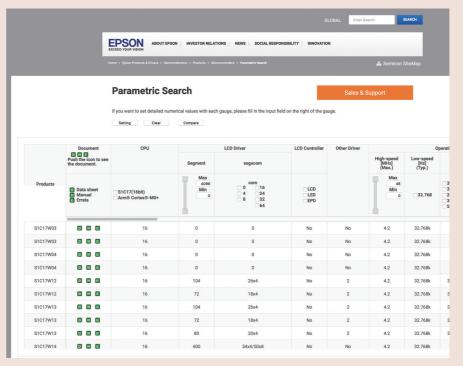
Downloadable information

- Hardware Development Tool
- Software Development Tool
- · Application Note
- · Sample Program
- MP Support Tool

Microcontrollers Parametric Search

It's useful for your model selection of microcontrollers.

You can download Data sheets, Technical manuals and Manual errata sheets.



Downloadable information

- · Data sheets
- · Technical manuals
- Manual errata sheets

MCUs MCU

Memo

MCUs

30

Evaluation board/kit and Development tool important notice

- 1. This evaluation board/kit or development tool is designed for use for engineering evaluation, demonstration, or development purposes only. Do not use it for other purposes. It is not intended to meet the requirements of design for finished products.
- 2. This evaluation board/kit or development tool is intended for use by an electronic engineer and is not a consumer product. The user should use it properly and in a safe manner. Seiko Epson dose not assume any responsibility or liability of any kind of damage and/or fire coursed by the use of it. The user should cease to use it when any abnormal issue occurs even during proper and safe use.
- 3. The part used for this evaluation board/kit or development tool may be changed without any notice.

NOTICE: PLEASE READ THE FOLLOWING NOTICE CAREFULLY BEFORE USING THIS DOCUMENT

The contents of this document are subject to change without notice.

- 1. This document may not be copied, reproduced, or used for any other purpose, in whole or in part, without the consent of the Seiko Epson Corporation ("Epson").
- 2. Before purchasing or using Epson products, please contact our sales representative for the latest information and always be sure to check the latest information published on Epson's official web sites and other sources.
- 3. Information provided in this document such as application circuits, programs, usage, etc., are for reference purposes only. Using the application circuits, programs, usage, etc. in the design of your equipment or systems is your own responsibility. Epson makes no guarantees against any infringements or damages to any third parties' intellectual property rights or any other rights resulting from the information. This document does not grant you any licenses, intellectual property rights or any other rights with respect to Epson products owned by Epson or any third parties.
- 4. Epson is committed to constantly improving quality and reliability, but semiconductor products in general are subject to malfunction and failure. By using Epson products, you shall be responsible for your hardware. Software and systems must be designed well enough to prevent death or injury as well as any property damage even if any of the malfunctions or failures might be caused by Epson products. When designing your products using Epson products, please be sure to check and comply with the latest information regarding Epson products (this document, specifications, data sheets, manuals, Epson's web site, etc.). When using the information included above materials such as product data, charts, technical contents, programs, algorithms and application circuit examples, you shall evaluate your products both on a stand-alone basis as well as within your overall systems. You shall be solely responsible for deciding whether or not to adopt and use Epson products.
- 5. Epson has prepared this document and programs provided in this document carefully to be accurate and dependable, but Epson does not guarantee that the information and the programs are always accurate and complete. Epson assumes no responsibility for any damages which you incur due to misinformation in this document and the programs.
- 6. No dismantling, analysis, reverse engineering, modification, alteration, adaptation, reproduction, etc., of Epson products is allowed.
- 7. Epson products have been designed, developed and manufactured to be used in general electronic applications (office equipment, communications equipment, measuring instruments, home electronics, etc.) and applications individually listed in this document ("General Purpose"). Epson products are NOT intended for any use beyond the General Purpose uses that requires particular/higher quality or reliability in order to refrain from causing any malfunction or failure leading to death, injury, serious property damage or severe impact on society, including, but not limited to those listed below. Therefore, you are advised to use Epson products only for General Purpose uses. Should you desire to buy and use Epson products for a particular purpose other than a General Purpose uses, Epson makes no warranty and disclaims with respect to Epson products, whether express or implied, including without limitation any implied warranty of merchantability or fitness for any particular purpose. Please be sure to contact our sales representative and obtain approval in advance.

[Particular purpose]

Space equipment (artificial satellites, rockets, etc.) /

Transportation vehicles and their control equipment (automobiles, aircraft, trains, ships, etc.) /

Medical equipment (other than applications individually listed in this document) / Relay equipment to be placed on ocean floor / Power station control equipment / Disaster or crime prevention equipment / Traffic control equipment / Financial equipment Other applications requiring similar levels of reliability as those listed above

- 8. Epson products listed in this document and our associated technologies shall not be used in any equipment or systems that laws and regulations in Japan or any other countries prohibit to manufacture, use or sell. Furthermore, Epson products and our associated technologies shall not be used for developing weapons of mass destruction, or any other military purposes or applications. If exporting Epson products or our associated technologies, you shall comply with the Foreign Exchange and Foreign Trade Control Act in Japan, Export Administration Regulations in the U.S.A. (EAR) and other export-related laws and regulations in Japan and any other countries and follow the required procedures as provided by the relevant laws and regulations.
- 9. Epson assumes no responsibility for any damages (whether direct or indirect) caused by or in relation with your non-compliance with the terms and conditions in this document.
- Epson assumes no responsibility for any damages (whether direct or indirect) incurred by any third party that you assign, transfer, loan, etc., Epson products to.
- 11. For more details or other concerns about this document, please contact our sales representative.
- 12. Company names and product names listed in this document are trademarks or registered trademarks of their respective companies.

©Seiko Epson Corporation 2023, All rights reserved.

[Registered trademarks, trademarks, and company names]

Design Compiler®: Synopsys Inc. in U.S.A.

NC-Verilog®: Cadence Design Systems Inc. in U.S.A.

SuperFlash®: Silicon Storage Technology, Inc., in the U.S.A.

Arm and Cortex are registered trademarks of Arm Limited (or its subsidiaries) in the US and/or elsewhere.

Other brand names and product names are trademarks or registered trademarks of their respective owners.

MMP Technology

Supply of this implementation of TPL's MMP technology does not convey a license nor imply a right under any patent, or any other industrial or intellectual property right of TPL, to use this implementation in any finished end-user final product. You are hereby notified that a license for such use is required from TPL. Contact: "mmp-licensing@tplgroup.net"

Rev.e1.2, 2022.9